

# HETERO JUNCTION FIELD EFFECT TRANSISTOR **NE3510M04**

### L TO S BAND LOW NOISE AMPLIFIER N-CHANNEL HJ-FET

DATA SHEET

#### FEATURES

- · Low noise figure and high associated gain
  - NF = 0.45 dB TYP., Ga = 16 dB TYP. @ f = 4 GHz, VDs = 2 V, ID = 15 mA
  - NF = 0.35 dB TYP., Ga = 19 dB TYP. @ f = 2 GHz, VDs = 2 V, ID = 10 mA (Reference only)
- Flat-lead 4-pin thin-type super minimold (M04) package

### **APPLICATIONS**

- · Satellite radio (SDARS, DMB, etc.) antenna LNA
- Low noise amplifier for microwave communication system

### **ORDERING INFORMATION**

Part Number	Order Number	Package	Quantity	Marking	Supplying Form
NE3510M04	NE3510M04-A	Flat-lead 4-pin thin-	50 pcs (Non reel)	V81	8 mm wide embossed taping
NE3510M04-T2	NE3510M04-T2-A	type super minimold (M04) (Pb-Free)	3 kpcs/reel		• Pin 1 (Source), Pin 2 (Drain) face the perforation side of the tape

**Remark** To order evaluation samples, contact your nearby sales office. Part number for sample order: NE3510M04-A

### ABSOLUTE MAXIMUM RATINGS (TA = +25°C)

Parameter	Symbol	Ratings	Unit
Drain to Source Voltage	VDS	4.0	V
Gate to Source Voltage	Vgs	-3.0	V
Drain Current	lь	loss	mA
Gate Current	la	140	μA
Total Power Dissipation	Ptot Note	125	mW
Channel Temperature	Tch	+150	°C
Storage Temperature	Tstg	-65 to +150	°C

Note Mounted on 1.08 cm<sup>2</sup> × 1.0 mm (t) glass epoxy PCB

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

### **RECOMMENDED OPERATING CONDITIONS (TA = +25°C)**

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Drain to Source Voltage	VDS	-	2	3	V
Drain Current	lo	-	15	30	mA
Input Power	Pin	-	-	0	dBm

### ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = +25°C, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Gate to Source Leak Current	lgso	$V_{GS} = -3 V$	-	0.5	10	μA
Saturated Drain Current	IDSS	$V_{DS} = 2 V, V_{GS} = 0 V$	42	70	97	mA
Gate to Source Cutoff Voltage	VGS (off)	V <sub>DS</sub> = 2 V, I <sub>D</sub> = 100 μA	-0.35	-0.7	-1.10	V
Transconductance	<b>g</b> m	V <sub>DS</sub> = 2 V, I <sub>D</sub> = 15 mA	70	-	-	mS
Noise Figure	NF	V <sub>DS</sub> = 2 V, I <sub>D</sub> = 15 mA, f = 4 GHz	-	0.45	0.65	dB
Associated Gain	Ga		14.5	16	-	dB
Gain 1 dB Compression	PO (1 dB)	V <sub>DS</sub> = 2 V, I <sub>D</sub> = 15 mA (Non-RF),	-	+11	-	dBm
Output Power		f = 4 GHz				

250

200

150

100

50

0

1.2

1.1

1.0

0.9

0.8

0.7

0.6

0.5

0.4

0.3

0.2

0.1

0.0

1.2

1.1

1.0

0.9

0.8

0.7

0.6

0.5

0.4

0.3

0.2

0.1

0.0

0

(dB)

NFmin

Minimum Noise Figure

0

NFmin (dB)

Figure

Minimum Noise

P<sub>tot</sub> (mW)

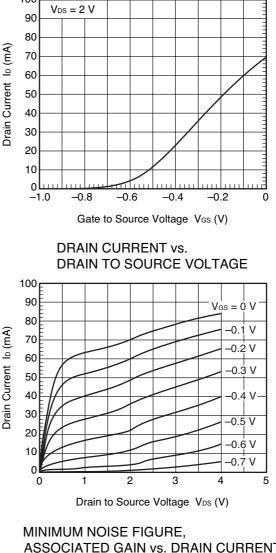
Total Power Dissipation

#### TOTAL POWER DISSIPATION DRAIN CURRENT vs. vs. AMBIENT TEMPERATURE GATE TO SOURCE VOLTAGE 100 $V_{DS} = 2 V$ Mounted on Glass Epoxy PCB 90 $(1.08 \text{ cm}^2 \times 1.0 \text{ mm}(t))$ 80 Drain Current Ip (mA) 70 60 50 40 30 20 10 0 50 100 150 200 250 -1.0-0.8 -0.6 Ambient Temperature TA (°C) MINIMUM NOISE FIGURE, ASSOCIATED GAIN vs. FREQUENCY 100 24 $V_{DS} = 2 V$ 22 90 $I_D = 15 \text{ mA}$ 20 80 (dB) 18 Drain Current Ip (mA) 70 å 16 60 Associated Gain 14 50 12 10 40 8 NF 30 6 20 4 10 2 口<sub>0</sub> 15 0 5 10 2 0 1 Frequency f (GHz) MINIMUM NOISE FIGURE, ASSOCIATED GAIN vs. DRAIN CURRENT 1.2 24 f = 2.0 GHz 22 1.1 (dB) $V_{DS} = 2 V$ 20 1.0 Ga (dB) NF<sub>min</sub> Ga 18 0.9 16 0.8 Minimum Noise Figure 0.7 14 Associated Gain 12 0.6 10 0.5 8 0.4 NFmin 6 0.3 4 0.2 2 0.1 \_<sub>0</sub> 35 5 10 15 20 25 30

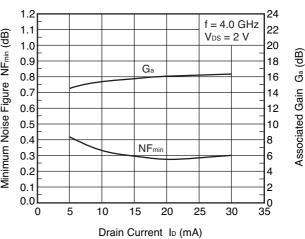
### TYPICAL CHARACTERISTICS (TA = +25°C, unless otherwise specified)

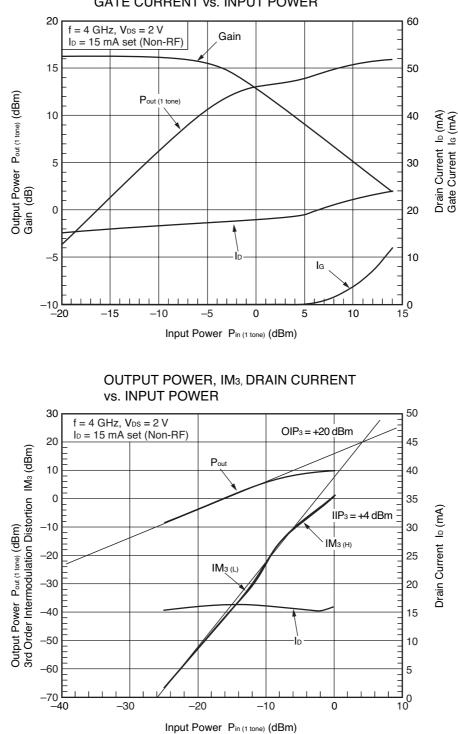
**Remark** The graphs indicate nominal characteristics.

Drain Current ID (mA)



### ASSOCIATED GAIN vs. DRAIN CURRENT





### OUTPUT POWER, GAIN, DRAIN CURRENT, GATE CURRENT vs. INPUT POWER

Remark The graphs indicate nominal characteristics.

### S-PARAMETERS

S-parameters/Noise parameters are provided on our web site in a form (S2P) that enables direct import to a microwave circuit simulator without keyboard input.

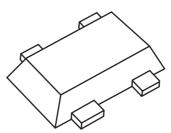
Click here to download S-parameters.

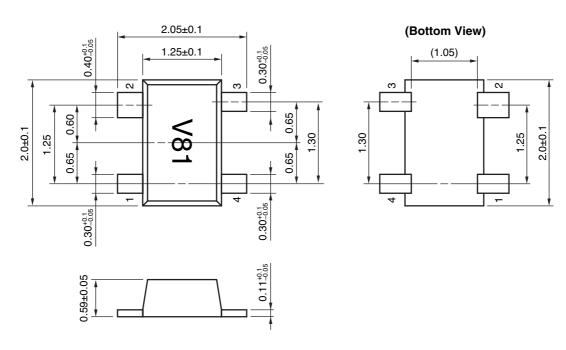
[RF and Microwave]  $\rightarrow$  [Device Parameters]

URL http://www.ncsd.necel.com/microwave/index.html

### PACKAGE DIMENSIONS

### FLAT-LEAD 4-PIN THIN-TYPE SUPER MINIMOLD (M04) (UNIT: mm)



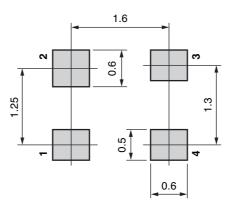


### **PIN CONNECTIONS**

- 1. Source
- 2. Drain
- 3. Source
- 4. Gate

### MOUNTING PAD DIMENSIONS (REFERENCE ONLY)

FLAT-LEAD 4-PIN THIN-TYPE SUPER MINIMOLD (M04) PACKAGE (UNIT: mm)



### **RECOMMENDED SOLDERING CONDITIONS**

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).

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- (1) "NEC Electronics" as used in this statement means NEC Electronics Corporation and also includes its majority-owned subsidiaries.
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Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	<ul> <li>Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.</li> </ul>
	<ol> <li>Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.</li> </ol>
	<ol><li>Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.</li></ol>
	Do not burn, destroy, cut, crush, or chemically dissolve the product.
	Do not lick the product or in any way allow it to enter the mouth.



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### Subject: Compliance with EU Directives

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CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (\*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentratio in CEL	
Lead (Pb)	< 1000 PPM	-A Not Detected	-AZ (*)
Mercury	< 1000 PPM	Not Detected	
Cadmium	< 100 PPM	Not Detected	
Hexavalent Chromium	< 1000 PPM	Not Detected	
РВВ	< 1000 PPM	Not Detected	
PBDE	< 1000 PPM	Not Detected	

## If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

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